



NOTES:

1. Dimensions are in inches & [mm].
2. Triangle on lid and notch in header denote pin 1.
3. Header material: Copper, with brazed-on CRS weld ring and overall nickel plating
4. Header flatness tolerance applies over rectangular area shown in bottom view.
5. Lid material: Solid nickel
6. Pin material: Solderable nickel-plated Alloy 52
7. Welded hermetic package seal
8. Isolation: 500 VDC any pin to case
9. Package weight: 2.05 oz [58 g]

TOLERANCES - UNLESS OTHERWISE SPECIFIED .XX = ±.01 [.254] .XXX = ±.005 [.127] ANG. = ±5°	 <small>WIRETECHNOLOGY PRECISION • POWER • ANALOG</small>	TITLE: JEDEC MO-127, 60mil pins, Cu	MODEL:	CU
		SUBJECT: PACKAGE OUTLINE		
ENGINEER: D-M	DRAWN BY: R.MOR	DCAL: 13225	SPL: 1 OF 1	FILENAME: CU
				REV: C
				DATE: 29MAY13